

LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V, LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV QUADRUPLE OPERATIONAL AMPLIFIERS

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

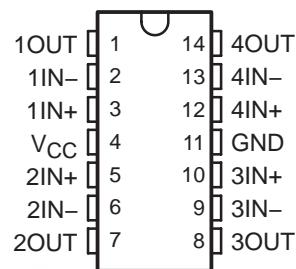
- 2-kV ESD Protection for:
 - LM224K, LM224KA
 - LM324K, LM324KA
 - LM2902K, LM2902KV, LM2902KAV
- Wide Supply Ranges
 - Single Supply . . . 3 V to 32 V
(26 V for LM2902)
 - Dual Supplies . . . ± 1.5 V to ± 16 V
(± 13 V for LM2902)
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Common-Mode Input Voltage Range Includes Ground, Allowing Direct Sensing Near Ground
- Low Input Bias and Offset Parameters
 - Input Offset Voltage . . . 3 mV Typ
A Versions . . . 2 mV Typ
 - Input Offset Current . . . 2 nA Typ
 - Input Bias Current . . . 20 nA Typ
A Versions . . . 15 nA Typ
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . 32 V
(26 V for LM2902)
- Open-Loop Differential Voltage Amplification . . . 100 V/mV Typ
- Internal Frequency Compensation

description/ordering information

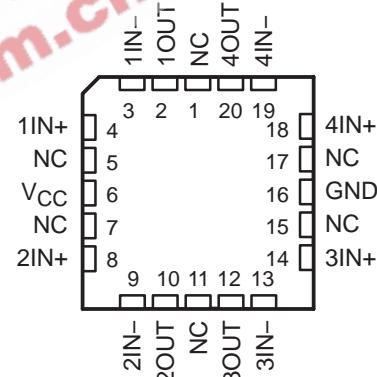
These devices consist of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies also is possible if the difference between the two supplies is 3 V to 32 V (3 V to 26 V for the LM2902), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, dc amplification blocks, and all the conventional operational-amplifier circuits that now can be more easily implemented in single-supply-voltage systems. For example, the LM124 can be operated directly from the standard 5-V supply that is used in digital systems and provides the required interface electronics, without requiring additional ± 15 -V supplies.

LM124 . . . D, J, OR W PACKAGE
 LM124A . . . J PACKAGE
 LM224, LM224A, LM224K, LM224KA . . . D OR N PACKAGE
 LM324, LM324K . . . D, N, NS, OR PW PACKAGE
 LM324A . . . D, DB, N, NS, OR PW PACKAGE
 LM324KA . . . D, N, NS, OR PW PACKAGE
 LM2902 . . . D, N, NS, OR PW PACKAGE
 LM2902K . . . D, DB, N, NS, OR PW PACKAGE
 LM2902KV, LM2902KAV . . . D OR PW PACKAGE
 (TOP VIEW)



LM124, LM124A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV
QUADRUPLE OPERATIONAL AMPLIFIERS**

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

description/ordering information (continued)

ORDERING INFORMATION

TA	V _{I0max} AT 25°C	MAX TESTED V _{CC}	PACKAGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	7 mV	30 V	PDIP (N)	Tube of 25	LM324N
				LM324KN	LM324KN
			SOIC (D)	Tube of 50	LM324D
				Reel of 2500	LM324DR
				Tube of 50	LM324KD
				Reel of 2500	LM324KDR
			SOP (NS)	Reel of 2000	LM324NSR
				Tube of 50	LM324KNS
				Reel of 2000	LM324KNSR
	3 mV	30 V	TSSOP (PW)	Tube of 90	LM324PW
				Reel of 2000	LM324PWR
				Tube of 90	LM324KPW
				Reel of 2000	LM324KPWR
			PDIP (N)	Tube of 25	LM324AN
				Tube of 25	LM324KAN
			SOIC (D)	Tube of 50	LM324AD
				Reel of 2500	LM324ADR
				Tube of 50	LM324KAD
				Reel of 2500	LM324KADR
			SOP (NS)	Reel of 2000	LM324ANSR
				Tube of 50	LM324KANS
				Reel of 2000	LM324KANSR
			SSOP (DB)	Reel of 2000	LM324ADBR
-25°C to 85°C	5 mV	30 V	PDIP (N)	Tube of 90	LM324APW
				Reel of 2000	LM324APWR
			SOIC (D)	Tube of 90	LM324KAPW
				Reel of 2000	LM324KAPWR
			PDIP (N)	LM224N	LM224N
				LM224KN	LM224KN
	3 mV	30 V	SOIC (D)	Tube of 50	LM224D
				Reel of 2500	LM224DR
				Tube of 50	LM224KD
				Reel of 2500	LM224KDR
			PDIP (N)	Tube of 25	LM224AN
				Tube of 25	LM224KAN
			SOIC (D)	Tube of 50	LM224AD
				Reel of 2500	LM224ADR
				Tube of 50	LM224KAD
				Reel of 2500	LM224KADR

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV**
QUADRUPLE OPERATIONAL AMPLIFIERS

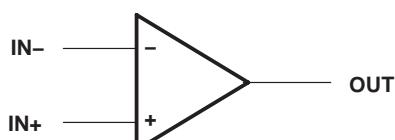
SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

ORDERING INFORMATION (CONTINUED)

T _A	V _{I0max} AT 25°C	MAX TESTED V _{CC}	PACKAGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	7 mV	26 V	PDIP (N)	Tube of 25	LM2902N
				Tube of 25	LM2902KN
			SOIC (D)	Tube of 50	LM2902D
				Reel of 2500	LM2902DR
				Tube of 50	LM2902KD
				Reel of 2500	LM2902KDR
			SOP (NS)	Reel of 2000	LM2902NSR
				Tube of 50	LM2902KNS
				Reel of 2000	LM2902KNSR
			SSOP (DB)	Tube of 80	LM2902KDB
				Reel of 2000	LM2902KDBR
			TSSOP (PW)	Tube of 90	LM2902PW
				Reel of 2000	LM2902PWR
				Tube of 90	LM2902KPW
				Reel of 2000	LM2902KPWR
		32 V	SOIC (D)	Reel of 2500	LM2902KVQDR
			TSSOP (PW)	Reel of 2000	LM2902KVQPWR
	2 mV	32 V	SOIC (D)	Reel of 2500	LM2902KAVQDR
			TSSOP (PW)	Reel of 2000	LM2902KAVQPWR
			CDIP (J)	Tube of 25	LM124J
			CFP (W)	Tube of 25	LM124W
-55°C to 125°C	5 mV	30 V	LCCC (FK)	Tube of 55	LM124FK
			SOIC (D)	Tube of 50	LM124D
				Reel of 2500	LM124DR
			CDIP (J)	Tube of 25	LM124AJ
			LCCC (FK)	Tube of 55	LM124AFK
					LM124AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

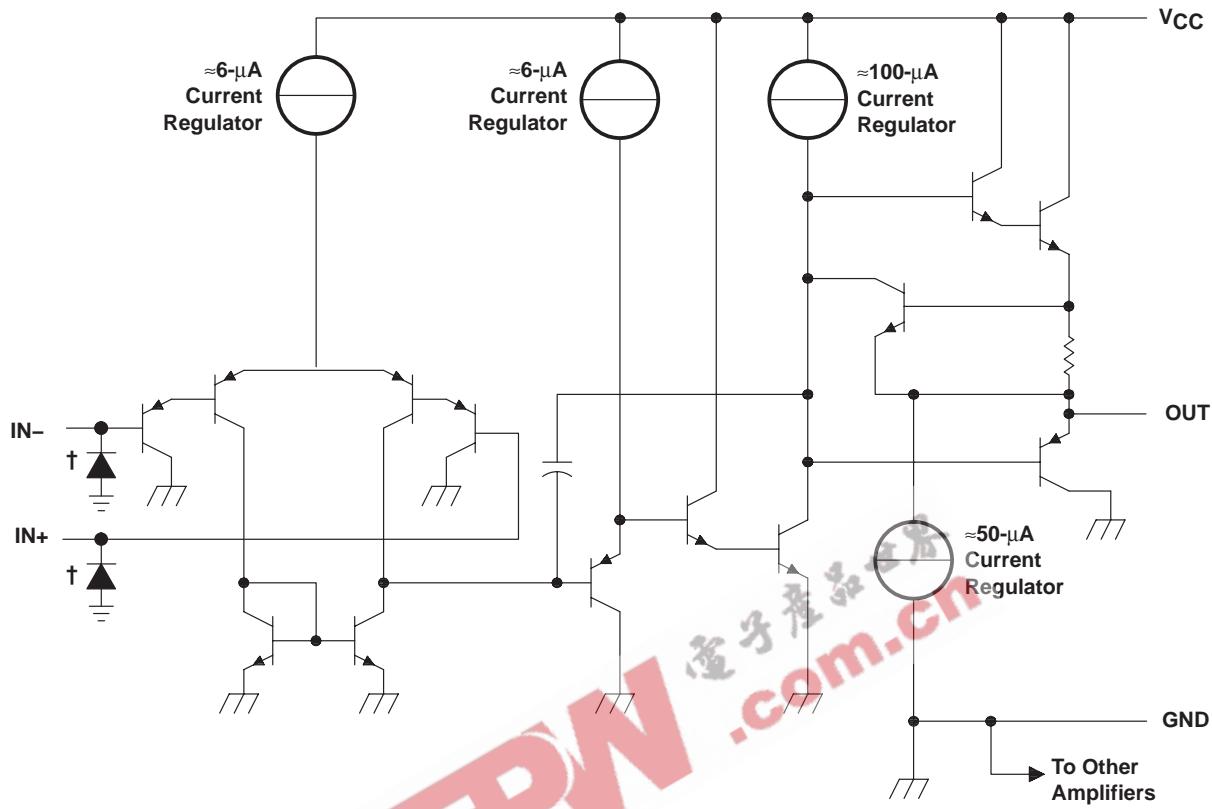
symbol (each amplifier)



**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV
QUADRUPLE OPERATIONAL AMPLIFIERS**

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

schematic (each amplifier)



COMPONENT COUNT (total device)	
Epi-FET	1
Transistors	95
Diodes	4
Resistors	11
Capacitors	4

† ESD protection cells - available on LM324K and LM324KA only

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV**
QUADRUPLE OPERATIONAL AMPLIFIERS

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

	LM2902	ALL OTHER DEVICES	UNIT
Supply voltage, V _{CC} (see Note 1)	±13 or 26	±16 or 32	V
Differential input voltage, V _{ID} (see Note 2)	±26	±32	V
Input voltage, V _I (either input)	-0.3 to 26	-0.3 to 32	V
Duration of output short circuit (one amplifier) to ground at (or below) T _A = 25°C, V _{CC} ≤ 15 V (see Note 3)	Unlimited	Unlimited	
Package thermal impedance, θ _{JA} (see Notes 4 and 5)	D package	86	86
	DB package	96	96
	N package	80	80
	NS package	76	76
	PW package	113	113
Package thermal impedance, θ _{JC} (see Notes 6 and 7)	FK package		5.61
	J package		15.05
	W package		14.65
Operating virtual junction temperature, T _J	150	150	°C
Case temperature for 60 seconds	FK package		260
Lead temperature 1.6 mm (1/16 inch) from case for 60 seconds	J or W package	300	300
Storage temperature range, T _{stg}	-65 to 150	-65 to 150	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
 2. Differential voltages are at IN+, with respect to IN-.
 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
 4. Maximum power dissipation is a function of T_{J(max)}, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_{J(max)} - T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.
 6. Maximum power dissipation is a function of T_{J(max)}, θ_{JC}, and T_C. The maximum allowable power dissipation at any allowable case temperature is P_D = (T_{J(max)} - T_C)/θ_{JC}. Operating at the absolute maximum T_J of 150°C can affect reliability.
 7. The package thermal impedance is calculated in accordance with MIL-STD-883.

ESD protection

TEST CONDITIONS		TYP	UNIT
Human-Body Model	LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV	±2	kV

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV
QUADRUPLE OPERATIONAL AMPLIFIERS**

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	T_A [‡]	LM124 LM224			LM324 LM324K			UNIT
			MIN	TYP [§]	MAX	MIN	TYP [§]	MAX	
V_{IO}	Input offset voltage $V_{CC} = 5\text{ V}$ to MAX, $V_{ICR} = V_{ICRmin}$, $V_O = 1.4\text{ V}$	25°C		3	5		3	7	mV
		Full range			7			9	
I_{IO}	Input offset current $V_O = 1.4\text{ V}$	25°C		2	30		2	50	nA
		Full range			100			150	
I_{IB}	Input bias current $V_O = 1.4\text{ V}$	25°C		-20	-150		-20	-250	nA
		Full range			-300			-500	
V_{ICR}	Common-mode input voltage range $V_{CC} = 5\text{ V}$ to MAX	25°C	0 to $V_{CC} - 1.5$			0 to $V_{CC} - 1.5$			V
		Full range	0 to $V_{CC} - 2$			0 to $V_{CC} - 2$			
V_{OH}	High-level output voltage $V_{CC} = \text{MAX}$	$R_L = 2\text{ k}\Omega$	25°C	$V_{CC} - 1.5$		$V_{CC} - 1.5$			V
		$R_L = 10\text{ k}\Omega$	25°C						
		$R_L = 2\text{ k}\Omega$	Full range	26		26			
		$R_L \geq 10\text{ k}\Omega$	Full range	27	28	27	28		
V_{OL}	Low-level output voltage $R_L \leq 10\text{ k}\Omega$	Full range		5	20		5	20	mV
A_{VD}	Large-signal differential voltage amplification $V_{CC} = 15\text{ V}$, $V_O = 1\text{ V}$ to 11 V , $R_L \geq 2\text{ k}\Omega$	25°C	50	100		25	100		V/mV
		Full range	25			15			
CMRR	Common-mode rejection ratio $V_{IC} = V_{ICRmin}$	25°C	70	80		65	80		dB
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC} / \Delta V_{IO}$)	25°C	65	100		65	100		dB
V_{O1}/V_{O2}	Crosstalk attenuation $f = 1\text{ kHz}$ to 20 kHz	25°C		120			120		dB
I_O	Output current $V_{CC} = 15\text{ V}$, $V_{ID} = 1\text{ V}$, $V_O = 0$	Source	25°C	-20	-30	-60	-20	-30	mA
		Source	Full range	-10			-10		
		Sink	25°C	10	20		10	20	mA
		Sink	Full range	5		5			
I_{OS}	Short-circuit output current $V_{CC} = 5\text{ V}$, GND at -5 V	$V_O = 0$,	25°C		± 40	± 60		± 40	mA
I_{CC}	Supply current (four amplifiers) $V_{CC} = 2.5\text{ V}$, No load	$V_O = 2.5\text{ V}$, No load	Full range	0.7	1.2		0.7	1.2	mA
		$V_{CC} = \text{MAX}$, $V_O = 0.5 V_{CC}$, No load	Full range	1.4	3		1.4	3	

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 30 V for the others.

[‡] Full range is -55°C to 125°C for LM124, -25°C to 85°C for LM224, and 0°C to 70°C for LM324.

[§] All typical values are at $T_A = 25^\circ\text{C}$.

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV**
QUADRUPLE OPERATIONAL AMPLIFIERS

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	$T_A \ddagger$	LM2902			LM2902V			UNIT
			MIN	TYP §	MAX	MIN	TYP §	MAX	
V_{IO} Input offset voltage	$V_{CC} = 5\text{ V}$ to MAX, $V_{IC} = V_{ICR\min}$, $V_O = 1.4\text{ V}$	Non-A-suffix devices	25°C	3	7	3	7	7	mV
			Full range		10			10	
		A-suffix devices	25°C			1	2	4	
			Full range						
$\Delta V_{IO}/\Delta T$ Input offset voltage temperature drift	$R_S = 0\text{ }\Omega$	Full range				7			$\mu\text{V}/^\circ\text{C}$
I_{IO} Input offset current	$V_O = 1.4\text{ V}$	25°C	2	50	50	2	50	150	nA
		Full range		300					
$\Delta I_{IO}/\Delta T$ Input offset current temperature drift		Full range				10			$\text{pA}/^\circ\text{C}$
I_{IB} Input bias current	$V_O = 1.4\text{ V}$	25°C	-20	-250	-250	-20	-250	-500	nA
		Full range		-500					
V_{ICR} Common-mode input voltage range	$V_{CC} = 5\text{ V}$ to MAX	25°C	0 to $V_{CC} - 1.5$			0 to $V_{CC} - 1.5$			V
		Full range	0 to $V_{CC} - 2$			0 to $V_{CC} - 2$			
V_{OH} High-level output voltage	$R_L = 2\text{ k}\Omega$	25°C							V
	$R_L = 10\text{ k}\Omega$	25°C	$V_{CC} - 1.5$			$V_{CC} - 1.5$			
	$V_{CC} = \text{MAX}$	$R_L = 2\text{ k}\Omega$	Full range	22		26			
		$R_L \geq 10\text{ k}\Omega$	Full range	23	24	27			
V_{OL} Low-level output voltage	$R_L \leq 10\text{ k}\Omega$	Full range		5	20	5	20		mV
A_{VD} Large-signal differential voltage amplification	$V_{CC} = 15\text{ V}$, $V_O = 1\text{ V}$ to 11 V , $R_L \geq 2\text{ k}\Omega$	25°C	25	100	100	25	100	15	V/mV
		Full range	15			15			
$CMRR$ Common-mode rejection ratio	$V_{IC} = V_{ICR\min}$	25°C	50	80	80	60	80		dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)		25°C	50	100	100	60	100		dB
V_{O1}/V_{O2} Crosstalk attenuation	$f = 1\text{ kHz}$ to 20 kHz	25°C		120		120			dB
I_O Output current	$V_{CC} = 15\text{ V}$, $V_{ID} = 1\text{ V}$, $V_O = 0$	Source	25°C	-20	-30	-60	-20	-30	mA
			Full range	-10			-10		
	$V_{CC} = 15\text{ V}$, $V_{ID} = -1\text{ V}$, $V_O = 15\text{ V}$	Sink	25°C	10	20	20	10	20	
			Full range	5		5			
	$V_{ID} = -1\text{ V}$, $V_O = 200\text{ mV}$	25°C		30		12	40		μA
I_{OS} Short-circuit output current	V_{CC} at 5 V , GND at -5 V	$V_O = 0$,	25°C	± 40	± 60	± 40	± 60		mA
I_{CC} Supply current (four amplifiers)	$V_O = 2.5\text{ V}$, No load	Full range		0.7	1.2	0.7	1.2		mA
	$V_{CC} = \text{MAX}$, $V_O = 0.5 V_{CC}$, No load	Full range		1.4	3	1.4	3		

† All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. MAX V_{CC} for testing purposes is 26 V for LM2902 and 32 V for LM2902V.

‡ Full range is -40°C to 125°C for LM2902.

§ All typical values are at $T_A = 25^\circ\text{C}$.

electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV
QUADRUPLE OPERATIONAL AMPLIFIERS**

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

PARAMETER	TEST CONDITIONS†	LM124A			LM224A			LM324A, LM324KA			UNIT
		MIN	TYP §	MAX	MIN	TYP §	MAX	MIN	TYP §	MAX	
V_{IO} Input offset voltage	$V_{CC} = 5\text{ V}$ to 30 V , $V_{IC} = V_{ICR\min}$, $V_O = 1.4\text{ V}$	25°C Full range	2	3	2	3	4	2	3	5	mV
I_{IO} Input offset current	$V_O = 1.4\text{ V}$	25°C Full range	10	2	15	2	15	2	30	nA	
I_B Input bias current	$V_O = 1.4\text{ V}$	25°C Full range	-50	-80	-15	-80	-15	-100	-100	nA	
V_{ICR} Common-mode input voltage range	$V_{CC} = 30\text{ V}$	0 to $V_{CC} - 1.5$ Full range	0 to $V_{CC} - 2$	0 to $V_{CC} - 1.5$ Full range	0 to $V_{CC} - 1.5$	0 to $V_{CC} - 2$	0 to $V_{CC} - 1.5$	0 to $V_{CC} - 1.5$	0 to $V_{CC} - 1.5$	-200	V
V_{OH} High-level output voltage	$R_L = 2\text{ k}\Omega$ $V_{CC} = 30\text{ V}$	25°C Full range	26	26	26	26	26	26	26	26	V
V_{OL} Low-level output voltage	$R_L \leq 10\text{ k}\Omega$	Full range	27	27	28	27	28	27	28	28	V
A_{vD} Large-signal differential voltage amplification	$V_{CC} = 15\text{ V}$, $V_O = 1\text{ V}$ to 11 V , $R_L \geq 2\text{ k}\Omega$	25°C Full range	50	100	50	100	50	100	50	100	mV
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICR\min}$	25°C Full range	70	25	70	25	70	25	70	25	dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_O$)		25°C Full range	65	65	65	65	65	65	65	65	dB
V_{O1}/V_{O2} Crosstalk attenuation	$f = 1\text{ kHz}$ to 20 kHz	25°C Full range	120	120	120	120	120	120	120	120	dB
I_O Output current	$V_{CC} = 15\text{ V}$, $V_D = 1\text{ V}$, $V_O = 0$	Source Full range	25°C Full range	-20	-20	-20	-20	-20	-20	-30	-60
	$V_{CC} = 15\text{ V}$, $V_D = -1\text{ V}$, $V_O = 15\text{ V}$	Sink Full range	25°C Full range	10	10	10	10	10	10	-10	-10
I_{OS} Short-circuit output current	$V_D = -1\text{ V}$, $V_O = 200\text{ mV}$	25°C GND at -5 V , $V_O = 0$	12	5	12	5	12	5	10	20	mA
I_{CC} (four amplifiers)	$V_O = 2.5\text{ V}$, No load	Full range	0.7	1.2	0.7	1.2	0.7	1.2	0.7	1.2	mA
	$V_{CC} = 30\text{ V}$, No load	Full range	1.4	3	1.4	3	1.4	3	1.4	3	µA

† All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.

‡ Full range is -5°C to 125°C for LM124A, -25°C to 85°C for LM224A, and 0°C to 70°C for LM324A.

§ All typical values are at $T_A = 25^\circ\text{C}$.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

**LM124, LM124A, LM224, LM224A, LM324, LM324A, LM2902, LM2902V,
LM224K, LM224KA, LM324K, LM324KA, LM2902K, LM2902KV, LM2902KAV**
QUADRUPLE OPERATIONAL AMPLIFIERS

SLOS066R – SEPTEMBER 1975 – REVISED JANUARY 2005

operating conditions, $V_{CC} = \pm 15$ V, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
SR	$R_L = 1 \text{ M}\Omega$, $C_L = 30 \text{ pF}$, $V_I = \pm 10 \text{ V}$ (see Figure 1)	0.5	$\text{V}/\mu\text{s}$
B_1	$R_L = 1 \text{ M}\Omega$, $C_L = 20 \text{ pF}$ (see Figure 1)	1.2	MHz
V_n	$R_S = 100 \Omega$, $V_I = 0 \text{ V}$, $f = 1 \text{ kHz}$ (see Figure 2)	35	$\text{nV}/\sqrt{\text{Hz}}$

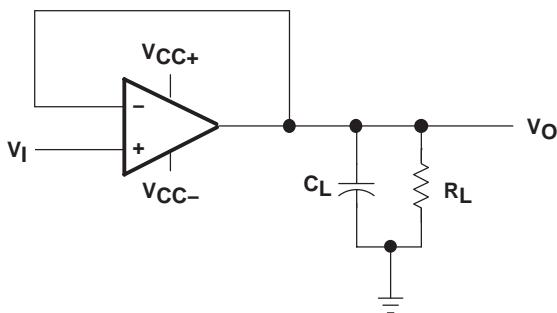


Figure 1. Unity-Gain Amplifier

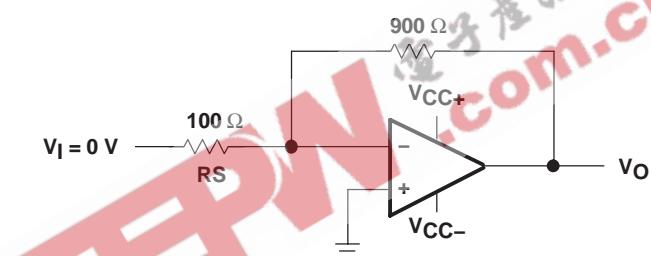


Figure 2. Noise-Test Circuit

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-7704301VCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
77043012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7704301CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
7704301DA	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
77043022A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7704302CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/11005BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124ADR	OBsolete	SOIC	D	14		TBD	Call TI	Call TI
LM124AFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM124AJ	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124AJB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124D	ACTIVE	SOIC	D	14	50	TBD	CU NIPDAU	Level-3-245C-168 HR
LM124DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM124DR	ACTIVE	SOIC	D	14	2500	TBD	CU NIPDAU	Level-3-245C-168 HR
LM124DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM124FKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM124J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124JB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124N	OBsolete	PDIP	N	14		TBD	Call TI	Call TI
LM124W	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM124WB	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM224AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

PACKAGE OPTION ADDENDUM

9-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
LM224DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KAD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KAN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM224KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM224NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

PACKAGE OPTION ADDENDUM

9-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM2902DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KAVQDR	NRND	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2902KAVQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KAVQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2902KAVQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDB	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBE4	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBG4	ACTIVE	SSOP	DB	14	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902KNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KNSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

PACKAGE OPTION ADDENDUM

9-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM2902KPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KVQDR	NRND	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2902KVQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902KVQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2902KVQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2902NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM2902PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2902QN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM324AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADBLE	OBSOLETE	SSOP	DB	14		TBD	Call TI	Call TI
LM324ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADB RG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
LM324AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ANSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWLE	OBsolete	TSSOP	PW	14	TBD		Call TI	Call TI
LM324APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KANE4	ACTIVE	PDIP	N	14	25	Pb-Free	CU NIPDAU	N / A for Pkg Type

PACKAGE OPTION ADDENDUM

9-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
(RoHS)								
LM324KANS	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KANSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KAPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324KNS	PREVIEW	SO	NS	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KNSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM324KPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324KPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM324NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWLE	OBsolete	TSSOP	PW	14		TBD	Call TI	Call TI
LM324PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM324Y	OBsolete	DIE SALE	Y	0		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

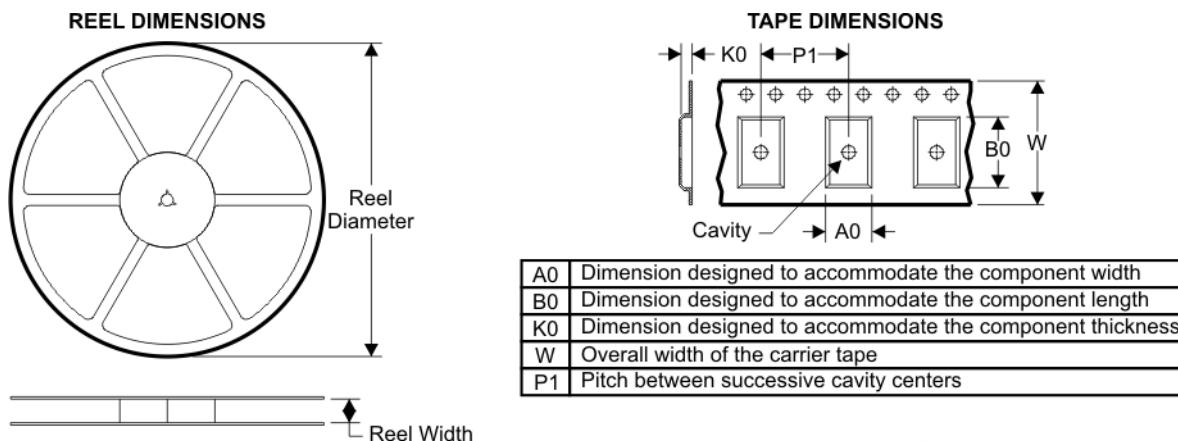
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

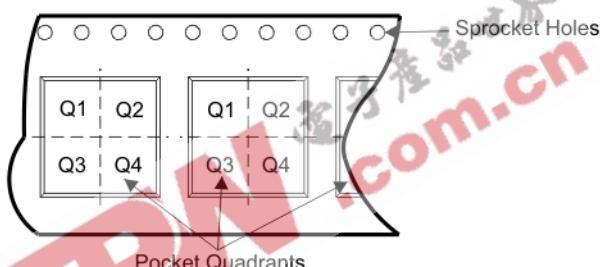
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

EEBN 电子商业网 **.com.cn**

TAPE AND REEL BOX INFORMATION



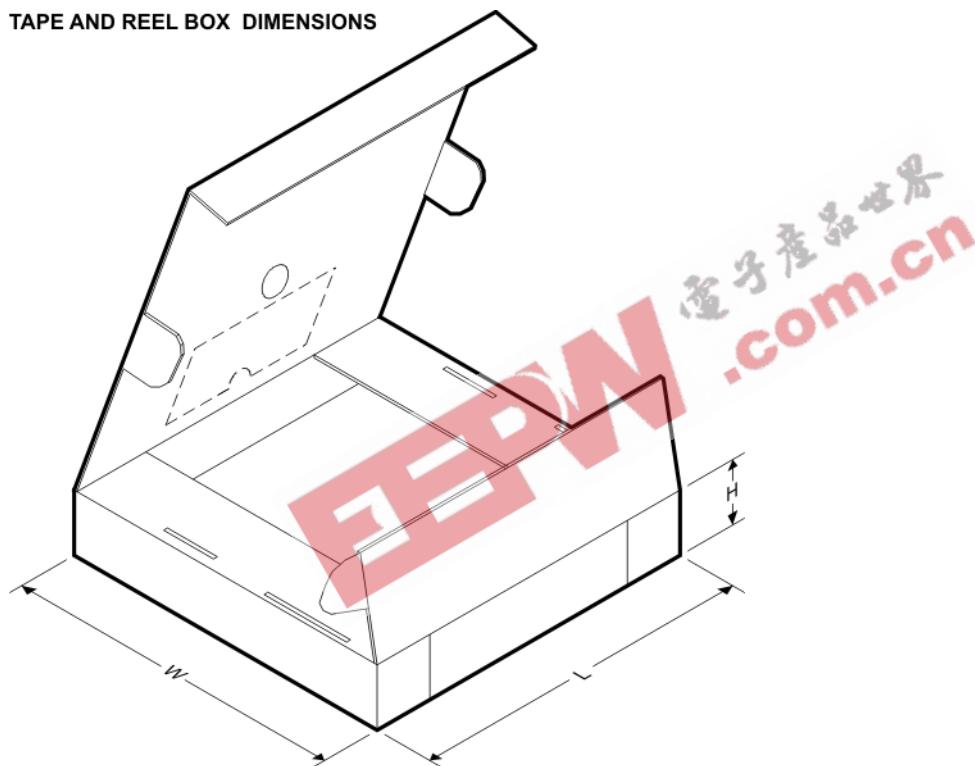
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM224ADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM224DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM224KADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM224KDR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM2902DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM2902DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM2902KDBR	DB	14	SITE 41	330	16	8.2	6.6	2.5	12	16	Q1
LM2902KDR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM2902KNSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM2902KPWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM2902NSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM2902PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM324ADBR	DB	14	SITE 41	330	16	8.2	6.6	2.5	12	16	Q1
LM324ADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM324ANSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM324APWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM324DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM324DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM324KADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1

Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM324KANSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM324KAPWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM324KDR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM324KNSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM324KPWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM324NSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM324PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1

TAPE AND REEL BOX DIMENSIONS

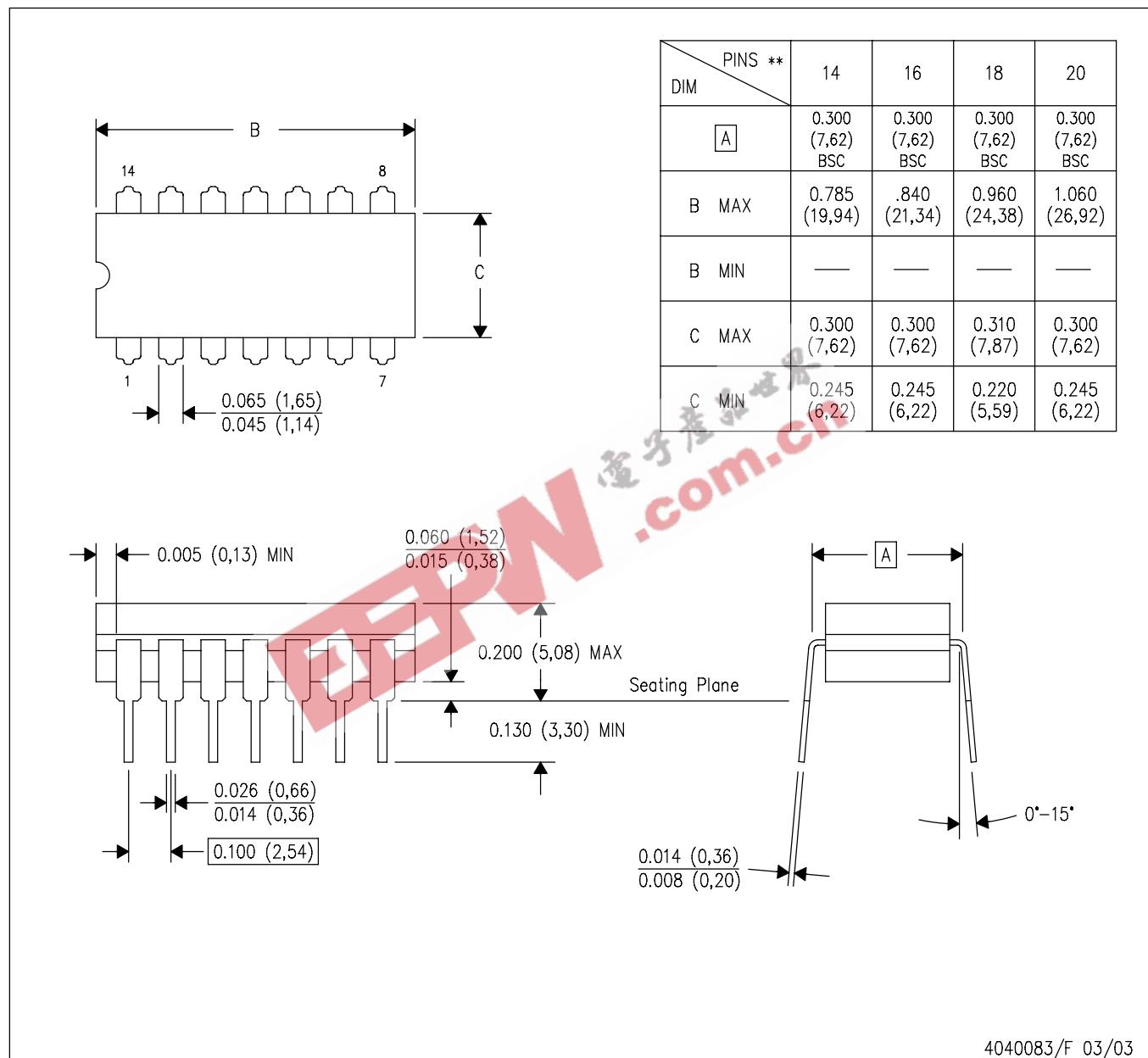


Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
LM224ADR	D	14	SITE 41	346.0	346.0	33.0
LM224DR	D	14	SITE 41	346.0	346.0	33.0
LM224KADR	D	14	SITE 41	346.0	346.0	33.0
LM224KDR	D	14	SITE 41	346.0	346.0	33.0
LM2902DR	D	14	SITE 27	342.9	336.6	28.58
LM2902DR	D	14	SITE 41	346.0	346.0	33.0
LM2902KDR	DB	14	SITE 41	346.0	346.0	33.0
LM2902KDR	D	14	SITE 41	346.0	346.0	33.0
LM2902KNSR	NS	14	SITE 41	346.0	346.0	33.0
LM2902KPWR	PW	14	SITE 41	346.0	346.0	29.0

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
LM2902NSR	NS	14	SITE 41	346.0	346.0	33.0
LM2902PWR	PW	14	SITE 41	346.0	346.0	29.0
LM324ADBR	DB	14	SITE 41	346.0	346.0	33.0
LM324ADR	D	14	SITE 41	346.0	346.0	33.0
LM324ANSR	NS	14	SITE 41	346.0	346.0	33.0
LM324APWR	PW	14	SITE 41	346.0	346.0	29.0
LM324DR	D	14	SITE 27	342.9	336.6	28.58
LM324DR	D	14	SITE 41	346.0	346.0	33.0
LM324KADR	D	14	SITE 41	346.0	346.0	33.0
LM324KANSR	NS	14	SITE 41	346.0	346.0	33.0
LM324KAPWR	PW	14	SITE 41	346.0	346.0	29.0
LM324KDR	D	14	SITE 41	346.0	346.0	33.0
LM324KNSR	NS	14	SITE 41	346.0	346.0	33.0
LM324KPWR	PW	14	SITE 41	346.0	346.0	29.0
LM324NSR	NS	14	SITE 41	346.0	346.0	33.0
LM324PWR	PW	14	SITE 41	346.0	346.0	29.0

J (R-GDIP-T**) CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN



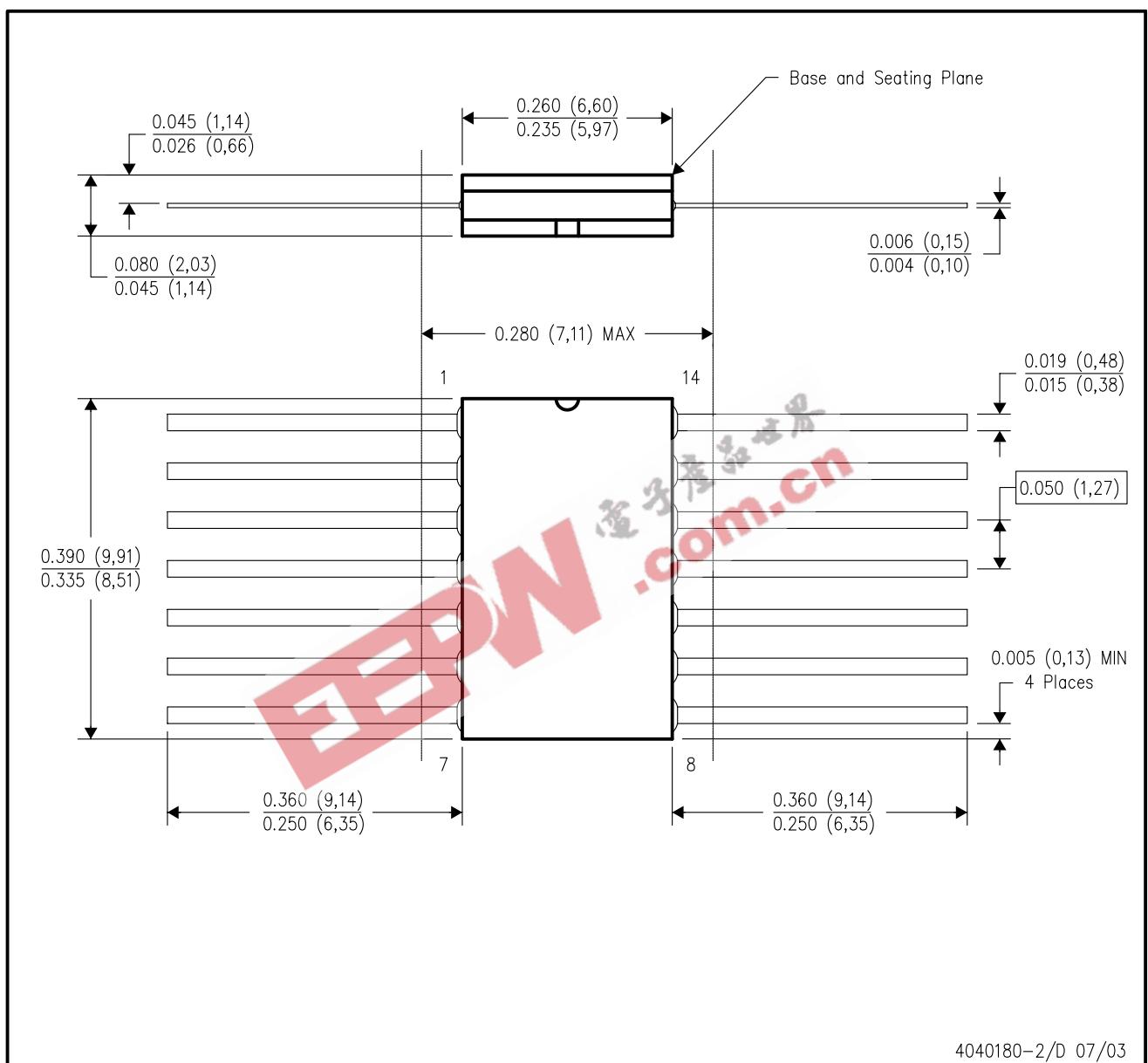
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MECHANICAL DATA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



4040180-2/D 07/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

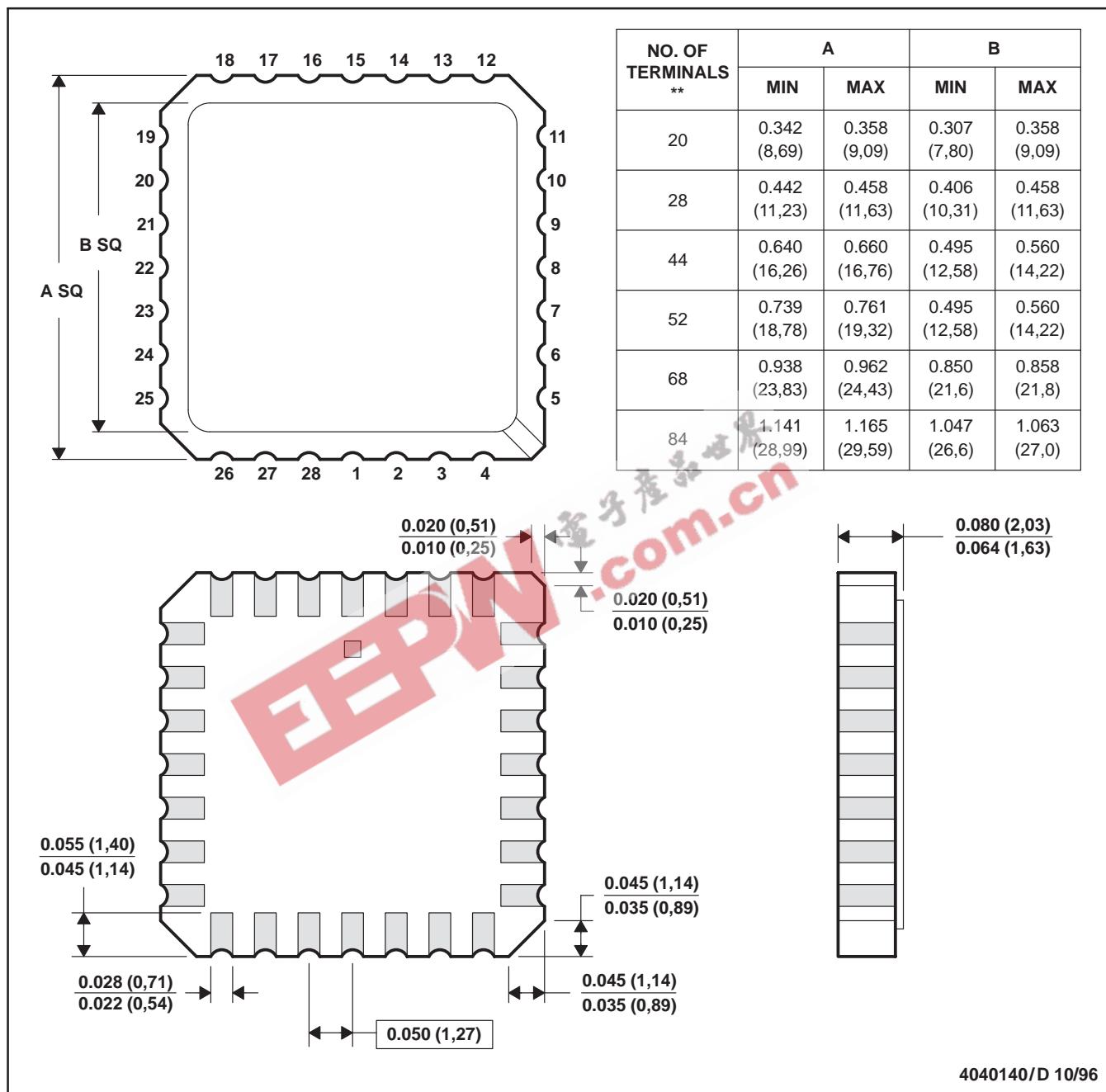
MECHANICAL DATA

MLCC006B – OCTOBER 1996

FK (S-CQCC-N)**

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



4040140/D 10/96

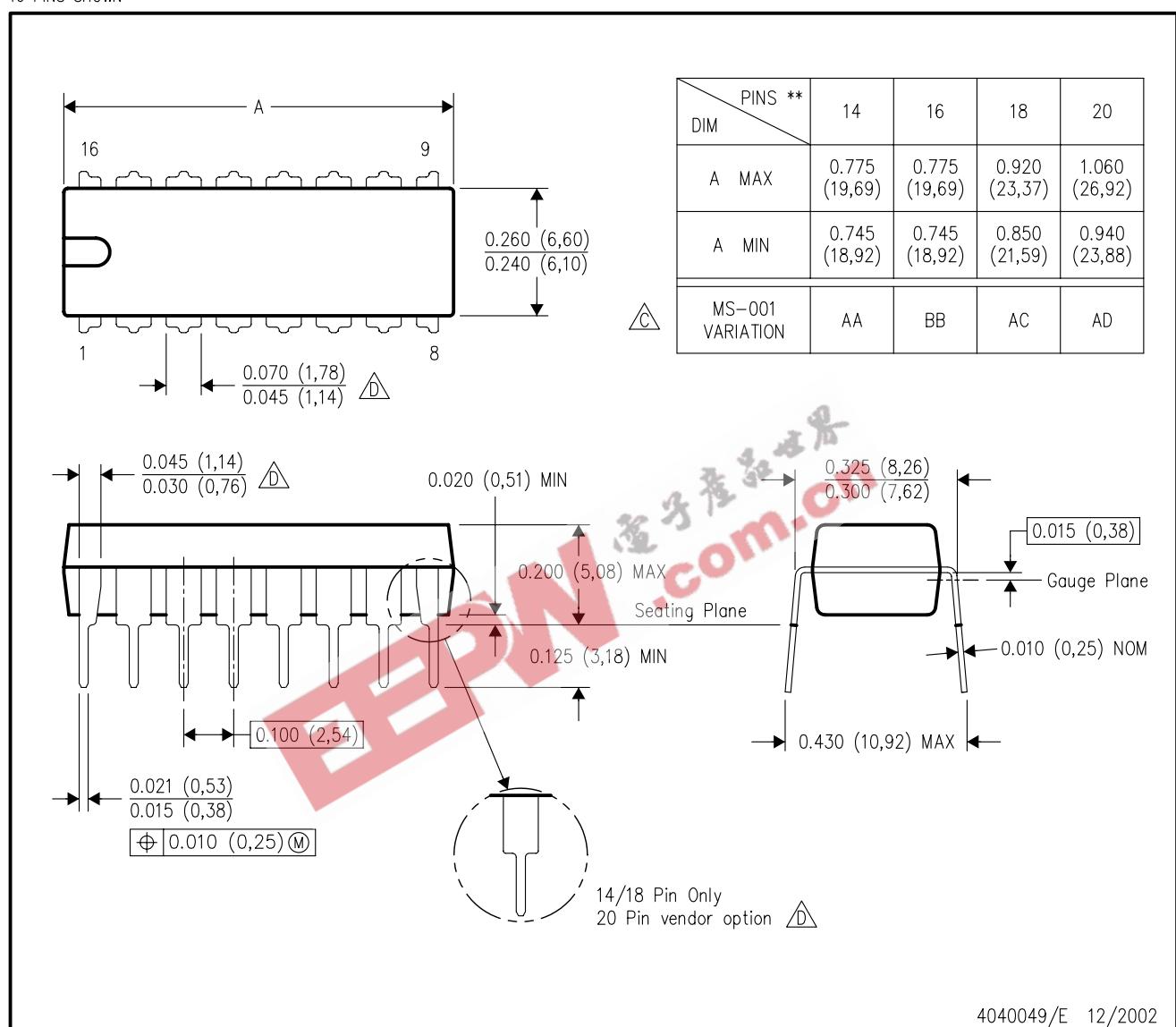
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a metal lid.
 D. The terminals are gold plated.
 E. Falls within JEDEC MS-004

MECHANICAL DATA

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



4040049/E 12/2002

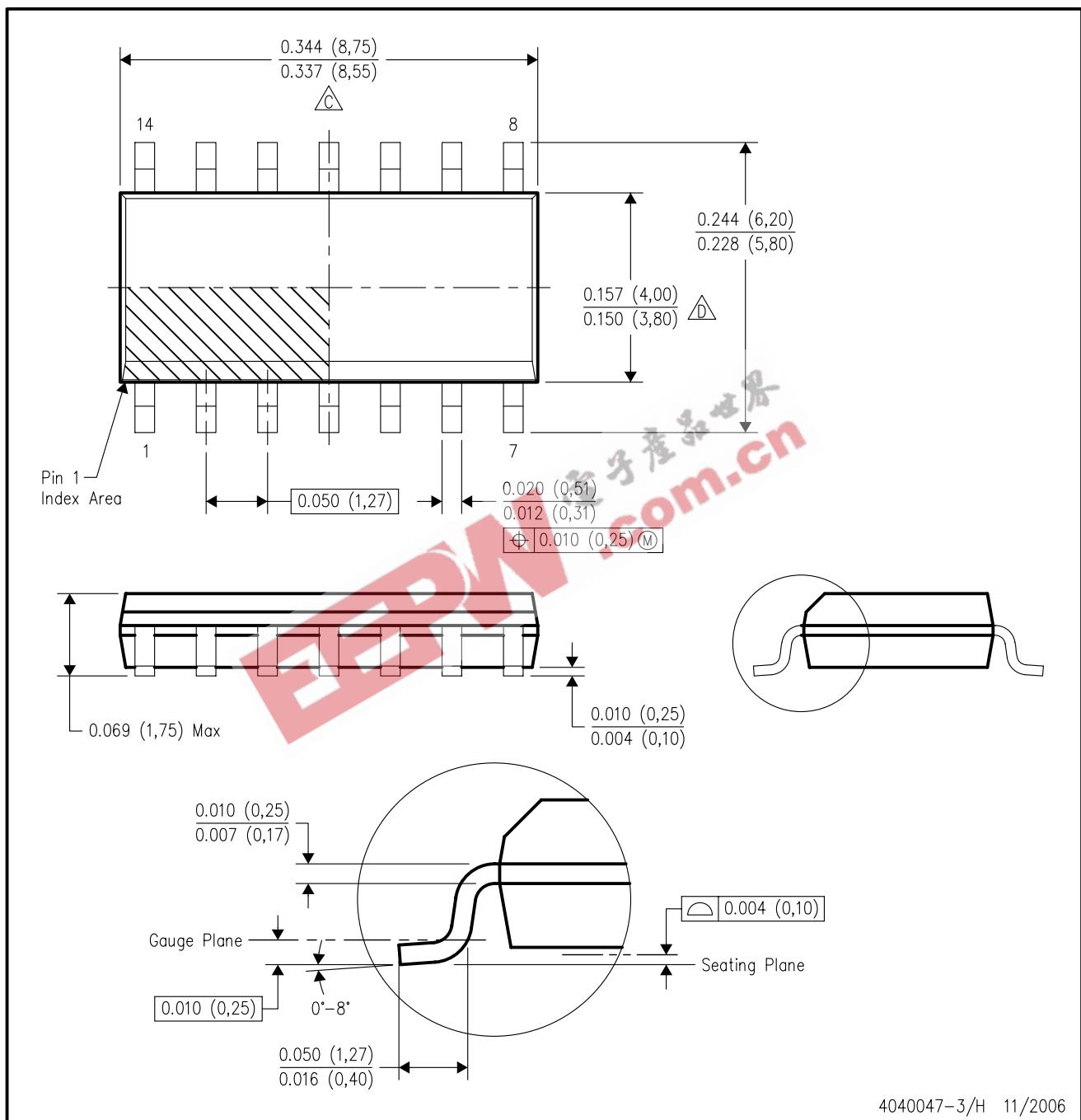
- NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

- △ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
△ The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



4040047-3/H 11/2006

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

△ C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

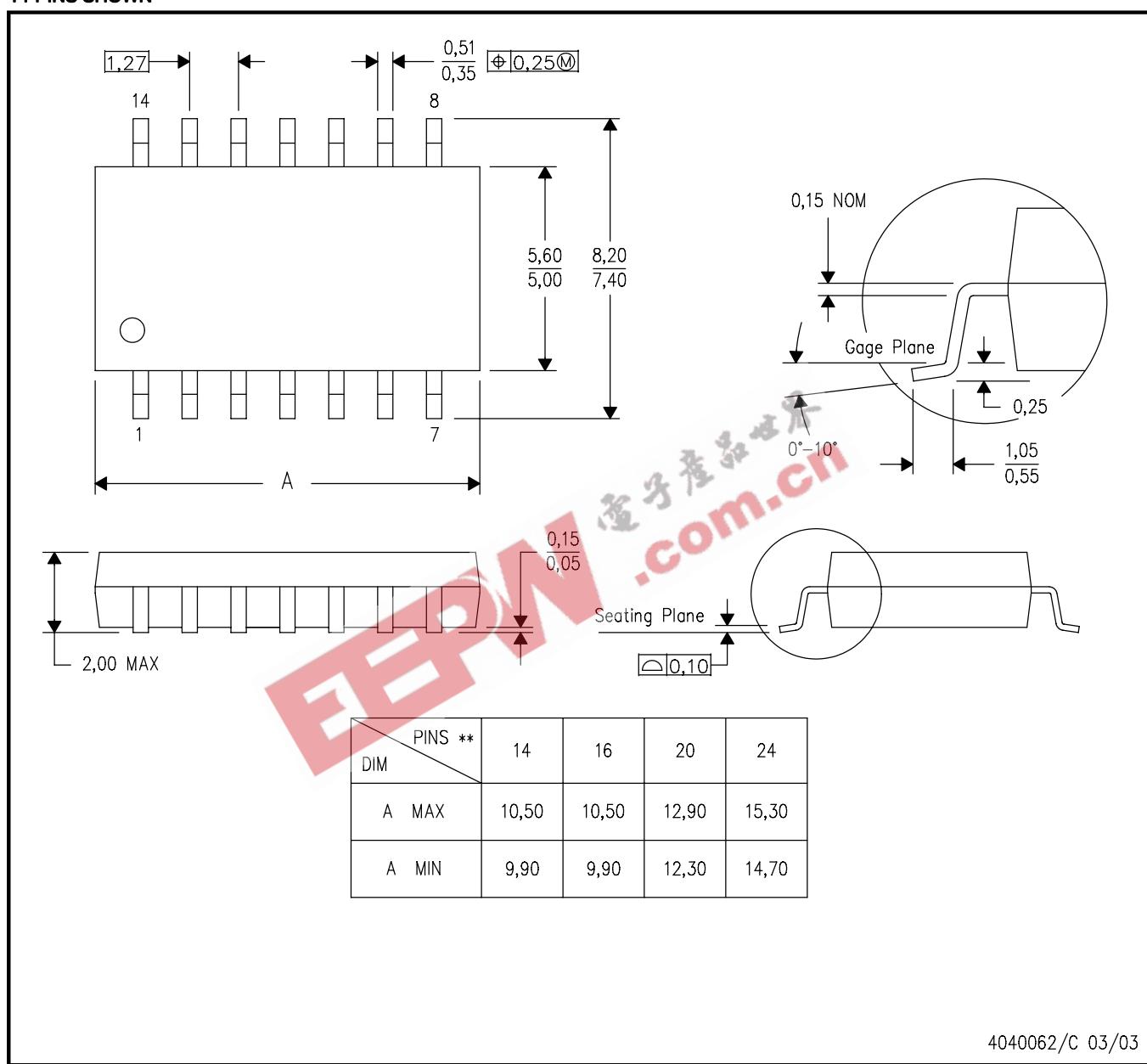
△ D Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
E. Reference JEDEC MS-012 variation AB.

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

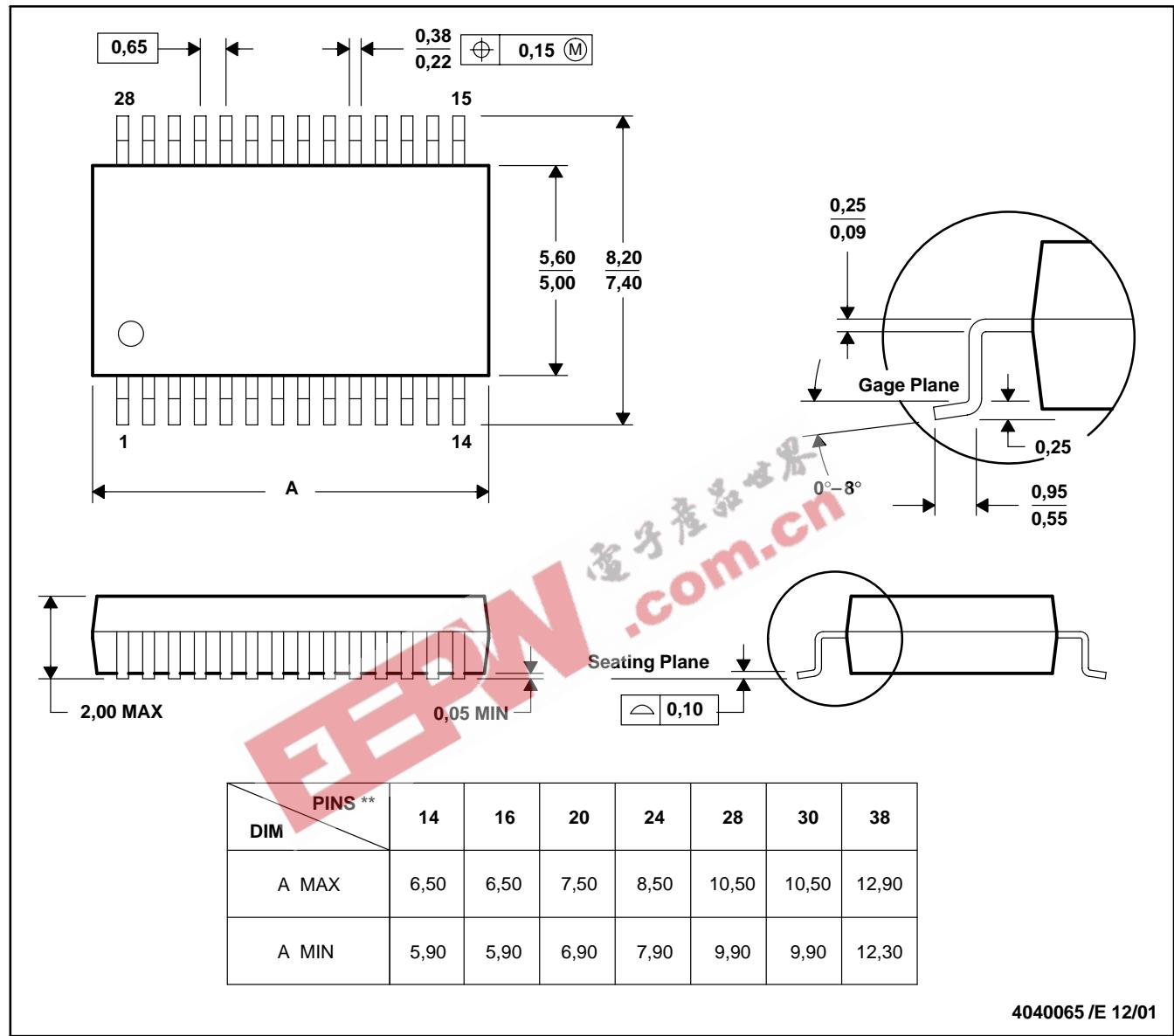
MECHANICAL DATA

MSSO002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)**

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - D. Falls within JEDEC MO-150

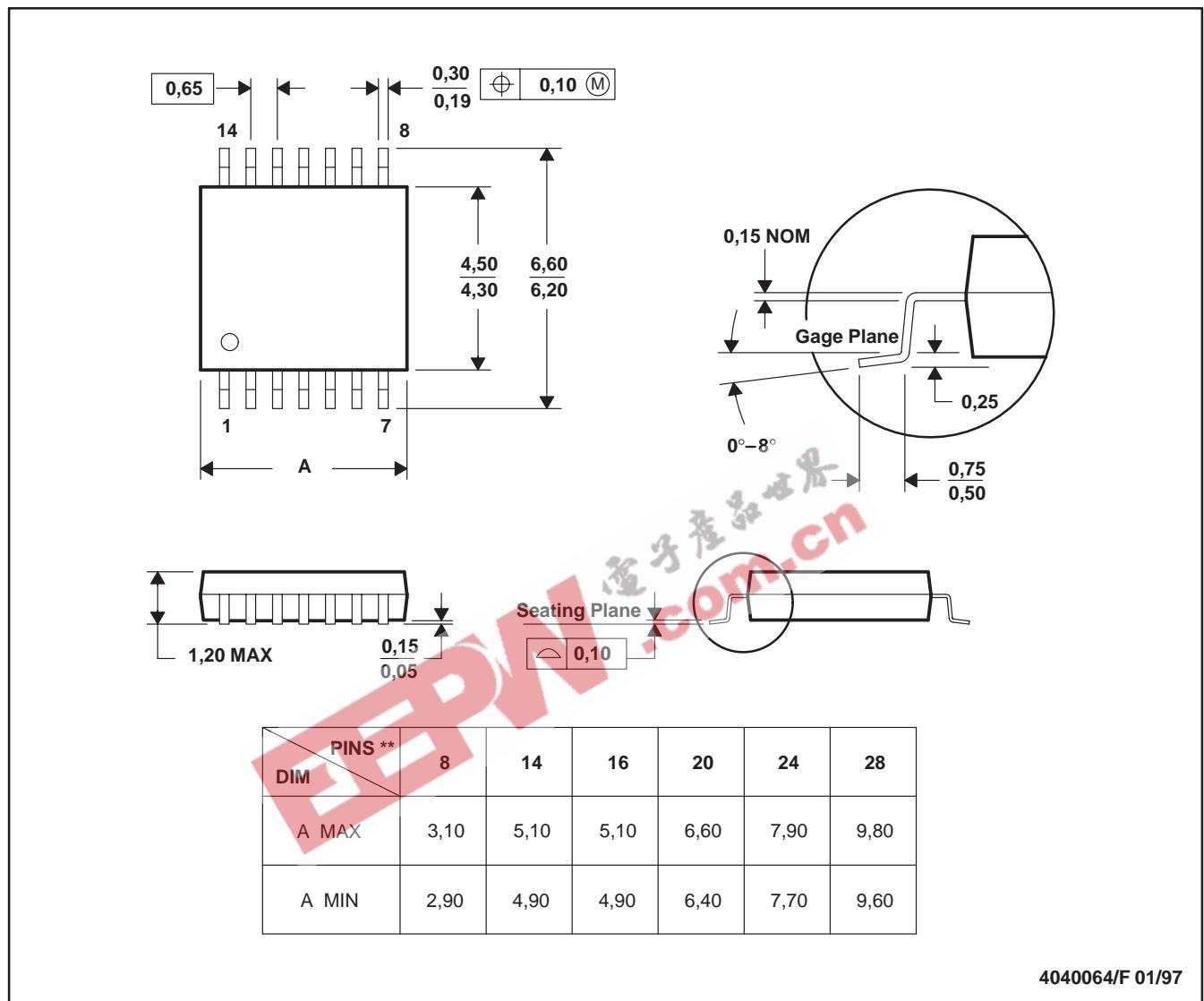
MECHANICAL DATA

MTSS001C – JANUARY 1995 – REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products	Applications
Amplifiers amplifier.ti.com	Audio www.ti.com/audio
Data Converters dataconverter.ti.com	Automotive www.ti.com/automotive
DSP dsp.ti.com	Broadband www.ti.com/broadband
Interface interface.ti.com	Digital Control www.ti.com/digitalcontrol
Logic logic.ti.com	Military www.ti.com/military
Power Mgmt power.ti.com	Optical Networking www.ti.com/opticalnetwork
Microcontrollers microcontroller.ti.com	Security www.ti.com/security
RFID www.ti-rfid.com	Telephony www.ti.com/telephony
Low Power Wireless www.ti.com/lpw	Video & Imaging www.ti.com/video
	Wireless www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2007, Texas Instruments Incorporated